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# IEEE ICMA 2024
## 2024 IEEE International Conference on Mechatronics and Automation
## August 4-7, 2024, Tianjin, China

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# Call for Papers   Index

The 2024 IEEE International Conference on Mechatronics and Automation (ICMA 2024) will take place in Tianjin, China from August 4 to August 7, 2024. Tianjin is a municipality direct under the Central Government, as well as an opening city. It's situated in the eastern part of the North China Plain, covering an area of 11,917 square km and with a population of 12,930,000.

As the host city of ICMA 2024, Tianjin not only provides the attendees with a great venue for this event, but also an unparalleled experience in Chinese history through several historical architectures. You are cordially invited to join us at IEEE ICMA 2024 in Tianjin. The objective of ICMA 2024 is to provide a forum for researchers, educators, engineers, and government officials involved in the general areas of mechatronics, robotics, automation and sensors to disseminate their latest research results and exchange views on the future research directions of these fields.

**The topics of interest include, but not limited to the following:**
- Intelligent mechatronics, robotics, biomimetics, automation, control systems,
- Opto-electronic elements and Materials, laser technology and laser processing
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- Control system modeling and simulation techniques and methodologies
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**Organized Sessions:** Proposals with the title, the organizers, and a brief statement of purpose of the session must be submitted to an OS Chair by April 10, 2024.
**Tutorials & Workshops:** Proposals for tutorials and workshops that address related topics must be submitted to one of the Tutorial/Workshop Chairs by May 1, 2024.

**Important Dates:**

| | | |
|---|---|---|
| April 10, | 2024 | **Full papers and organized session proposals** |
| May 1, | 2024 | **Proposals for tutorials and workshops** |
| May 15, | 2024 | **Notification of paper and session acceptance** |
| June 1, | 2024 | **Submission of final papers in IEEE PDF format** |

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